



Micro Commercial Components
21201 Itasca Street Chatsworth
CA 91311

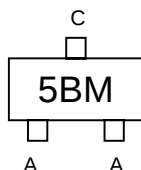
Phone: (818) 701-4933

Fax: (818) 701-4939

MMBD6100

Features

- Low Current Leakage
- SOT-23 Package For Surface Mount Application
- Capable of 225Watts of Power Dissipation



Monolithic Dual Switching Diode

Maximum Ratings

- Operating Temperature: -55°C to $+150^{\circ}\text{C}$
- Storage Temperature: -55°C to $+150^{\circ}\text{C}$
- Maximum Thermal Resistance; 556°C/W Junction To Ambient

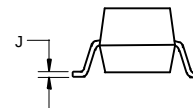
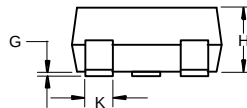
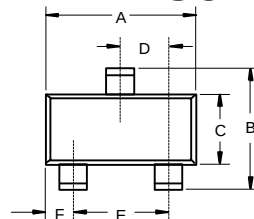
Electrical Characteristics @ 25°C Unless Otherwise Specified

Reverse Voltage	V_R	70V	
Minimum Reverse Breakdown Voltage	V_{BR}	70V	$I_{BR}=100\mu\text{A}$
Forward Current	I_F	200mA	
Power Dissipation FR-5 Board ⁽¹⁾	P_{TOT}	225mW 1.8mW/ $^{\circ}\text{C}$	$T_A=25^{\circ}\text{C}$ Derate above 25°C
Power Dissipation Alumina Substrate ⁽²⁾	P_{TOT}	300mW 2.4mW/ $^{\circ}\text{C}$	$T_A=25^{\circ}\text{C}$ Derate above 25°C
Peak Forward Surge Current	I_{FSM}	500mA	8.3ms, half sine
Junction Temperature	T_J	150°C	
Forward Voltage	V_F	0.55~0.7V 0.85~1.1V	$I_F=1.0\text{mA}$ $I_F=100\text{mA}$
Maximum Reverse Voltage Leakage Current	I_R	0.1 μA	$V_R=50\text{V}$ $T_A=25^{\circ}\text{C}$,
Maximum Junction Capacitance	C_J	2.5pF	Measured at $V_R=0\text{V}$
Maximum Reverse Recovery Time	T_{rr}	4.0nS	$I_F=I_R=10\text{mA}$ $I_{R(RCE)}=1.0\text{mA}$

1) FR-5=1.0 × 0.75 × 0.062 in.

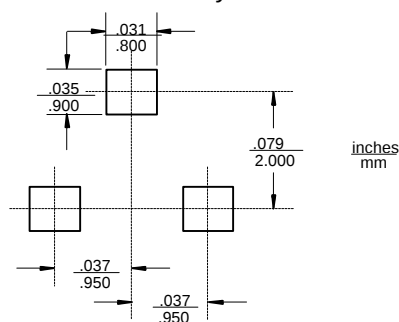
2) Alumina=0.4 × 0.3 × 0.024 in. 99.5% alumina.

SOT-23



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	.110	.120	2.80	3.04	
B	.083	.098	2.10	2.64	
C	.047	.055	1.20	1.40	
D	.035	.041	.89	1.03	
E	.070	.081	1.78	2.05	
F	.018	.024	.45	.60	
G	.0005	.0039	.013	.100	
H	.035	.044	.89	1.12	
J	.003	.007	.085	.180	
K	.015	.020	.37	.51	

Suggested Solder Pad Layout



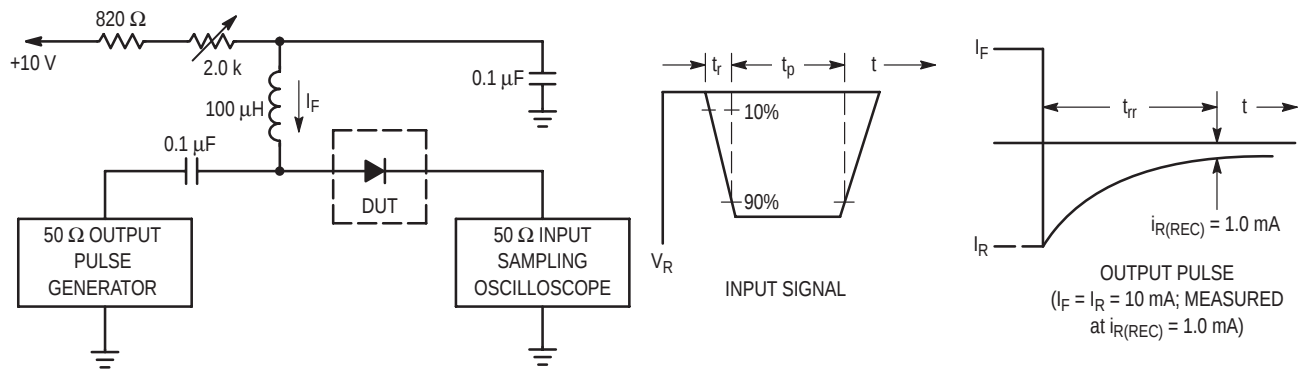


Figure 1. Recovery Time Equivalent Test Circuit

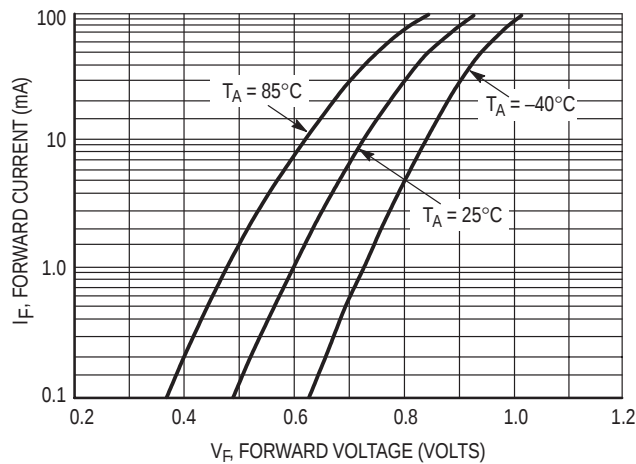


Figure 2. Forward Voltage

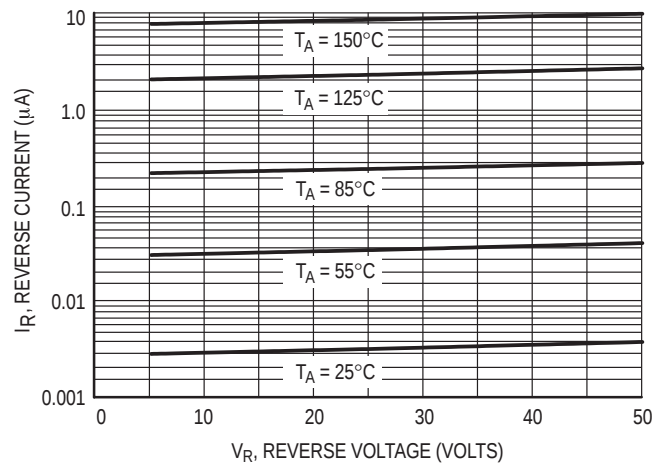


Figure 3. Leakage Current

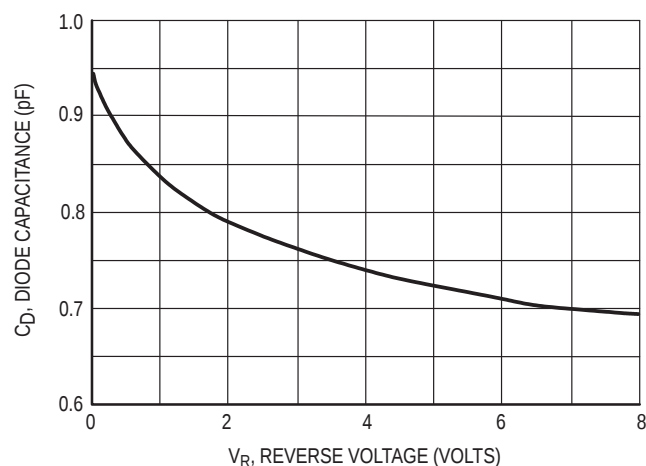


Figure 4. Capacitance